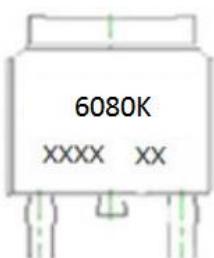
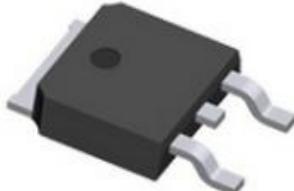
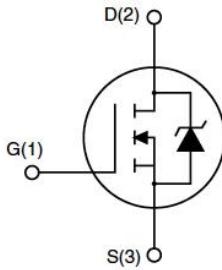


6080K

68V N-channel enhancement mode MOSFET

Features	General Description
<ul style="list-style-type: none"> Extremely Low RDS(on): Typ.RDS(on) = 7.9mΩ @VGS=10 V,Id=30 A Low gate charge (typical 75 nC) Fast switching 100% avalanche tested 	<p>The 6080K uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.</p>

Package	
	
	
Marking and pin assignment	TO-252top view
	
	Schematic diagram

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	60	V
I_D	Drain Current - Continuous ($T_C= 25^\circ\text{C}$) - Continuous ($T_C= 70^\circ\text{ C}$)	80	A
		52*	A
I_{DM}	Drain Current - Pulsed (Note 1)	208*	A
V_{GS}	Gate-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	285	mJ
E_{AR}	Repetitive Avalanche Energy (Note 1)	40	mJ
dv/dt	Peak diode recovery dv/dt (note 3)	5.5	V/ns
P_D	Power Dissipation ($TC = 25^\circ\text{C}$) - Derate above 25°C	108	W
		1.6	W/ $^\circ\text{C}$
T_j, T_{stg}	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T	Maximum lead temperature for soldering,purpose, 1/8 from case for 5 seconds	280	$^\circ\text{C}$

* Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.58	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.8	$^\circ\text{C/W}$

6080K

68V N-channel enhancement mode MOSFET

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}} = 0 \text{ V}, \text{I}_D = 250 \mu\text{A}$	60			V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	$\text{I}_D = 250 \mu\text{A}$, Referenced to 25°C		68		mV°C
I_{DSS}	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}} = 60 \text{ V}, \text{V}_{\text{GS}} = 0 \text{ V}$		1		μA
		$\text{V}_{\text{DS}} = 50 \text{ V}, \text{T}_c = 125^\circ\text{C}$		10		μA
I_{GSSF}	Gate Leakage Current, Forward	$\text{V}_{\text{GS}} = 20 \text{ V}, \text{V}_{\text{DS}} = 0 \text{ V}$		100		nA
I_{GSSR}	Gate Leakage Current, Reverse	$\text{V}_{\text{GS}} = -20 \text{ V}, \text{V}_{\text{DS}} = 0 \text{ V}$		-100		nA
On Characteristics						
$\text{V}_{\text{GS(TH)}}$	Gate Threshold voltage	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250 \mu\text{A}$	2	3	4	V
$R_{\text{DS(On)}}$	Drain-Source on-state resistance	$\text{V}_{\text{GS}} = 10 \text{ V}, \text{I}_D = 30 \text{ A}$		7.9	9.5	$\text{m}\Omega$
g_{fs}	Forward Transconductance	$\text{V}_{\text{DS}} = 10 \text{ V}, \text{I}_D = 30 \text{ A}$ (Note 3)		34.0		S
Dynamic Characteristics						
C_{iss}	Input capacitance	$\text{V}_{\text{DS}} = 25 \text{ V}, \text{V}_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$		3988		pF
C_{oss}	Output capacitance			339		pF
C_{rss}	Reverse transfer capacitance			312		pF
Switching Characteristics						
$t_{\text{d(on)}}$	Turn On Delay Time			22		ns
t_r	Rising Time	$\text{V}_{\text{DD}} = 35 \text{ V}, \text{I}_D = 40 \text{ A}, \text{V}_{\text{GS}} = 10 \text{ V}, \text{R}_G = 4.7 \Omega$ (Note 3, 4)		54		ns
$t_{\text{d(off)}}$	Turn Off Delay Time			50		ns
t_f	Fall Time			25		ns
Q_g	Total Gate Charge	$\text{V}_{\text{DS}} = 35 \text{ V}, \text{I}_D = 40 \text{ A}, \text{V}_{\text{GS}} = 10 \text{ V}$ (Note 3, 4)		78		nC
Q_{gs}	Gate-Source Charge			26		nC
Q_{gd}	Gate-Drain Charge			22		nC
R_g	Gate Resistance	$\text{V}_{\text{DS}} = 0 \text{ V}$, Scan F mode		2.4		Ω
Drain-Source Diode Characteristics and Maximum Ratings						
I_s	Maximum Continuous Drain-Source Diode Forward Current			80		A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current			208		A
V_{SD}	Diode Forward Voltage	$\text{V}_{\text{GS}} = 0 \text{ V}, I_s = 40 \text{ A}$		1.2		V
I_{rrm}	Reverse recovery current	$I_s = 40 \text{ A}, \text{V}_{\text{GS}} = 0 \text{ V}, dI/dt = 100 \text{ A/us}$		-1.2		A
T_{rr}	Reverse recovery time			25		ns
Q_{rr}	Reverse recovery charge			19		nC

Notes:1. Repetitive Rating : Pulse width limited by maximum junction temperature

2. L = 0.95 mH, IAS = 32 A, VDD = 10V, RG = 25 Ω , Starting $T_j = 25^\circ\text{C}$

3. ISD $\leq 40\text{A}$, $dI/dt = 100\text{A/us}$, VDD $\leq \text{BV}_{\text{DSS}}$, Starting $T_j = 25^\circ\text{C}$

4. Pulse Test : Pulse width $\leq 300\text{us}$, Duty cycle $\leq 2\%$

5. Essentially independent of operating temperature

6080K

68V N-channel enhancement mode MOSFET

Typical Characteristics

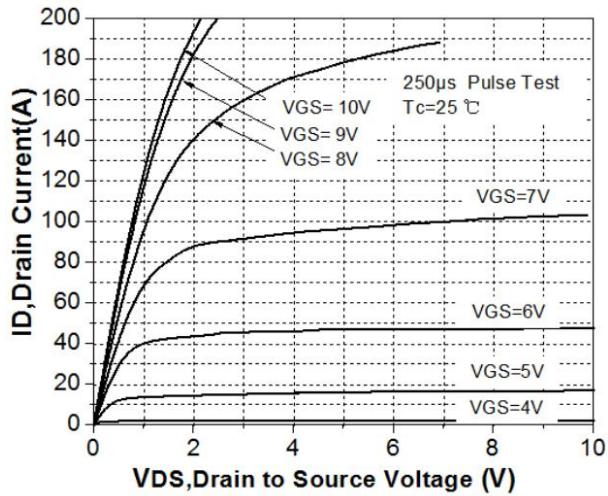


Figure 1. On-Region Characteristics

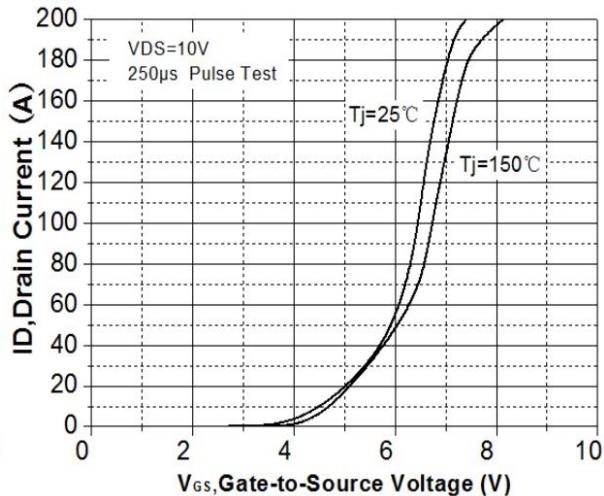


Figure 2. Transfer Characteristics

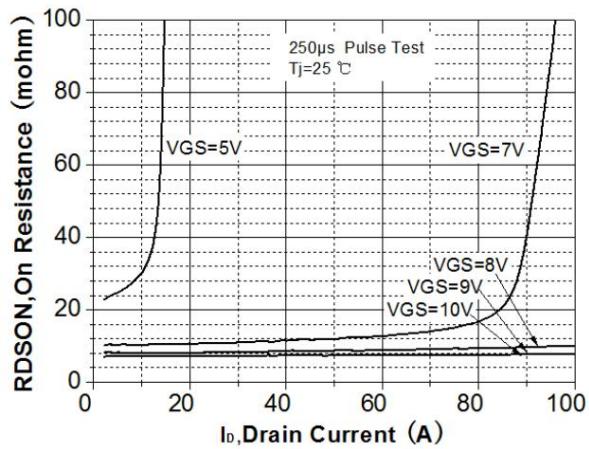


Figure 3. On-Resistance Variation vs
Drain Current and Gate Voltage

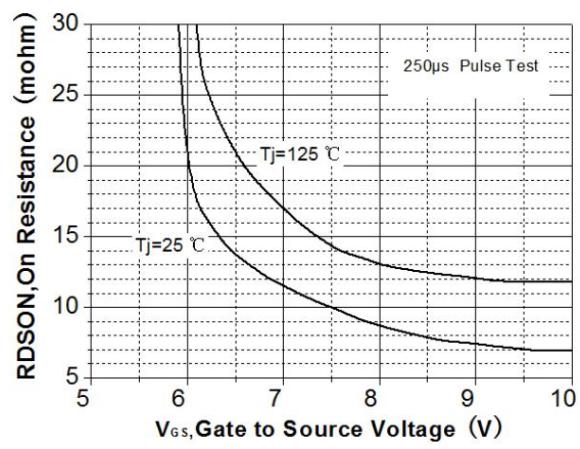


Figure 4. On-Resistance vs. Gate to
Source Voltage

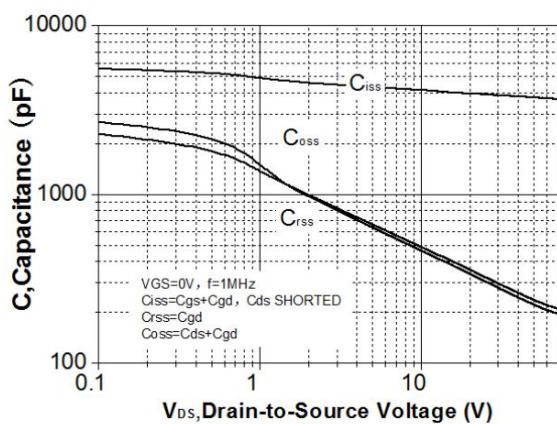


Figure 5. Capacitance Characteristics

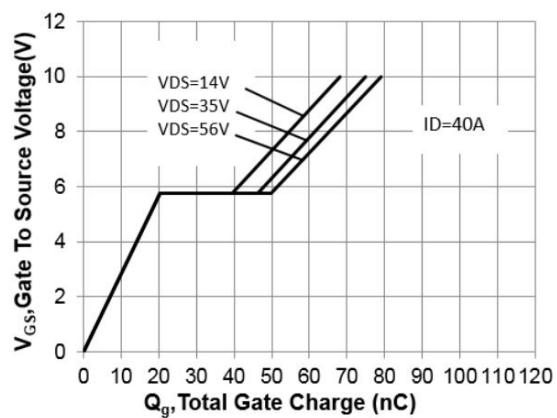


Figure 6. Gate Charge Characteristics

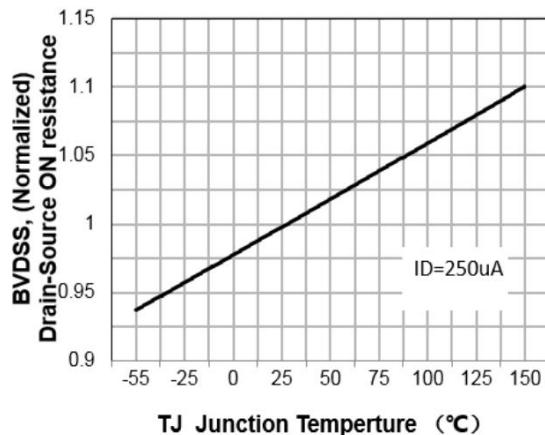


Figure 7. Breakdown Voltage Variation
vs Temperature

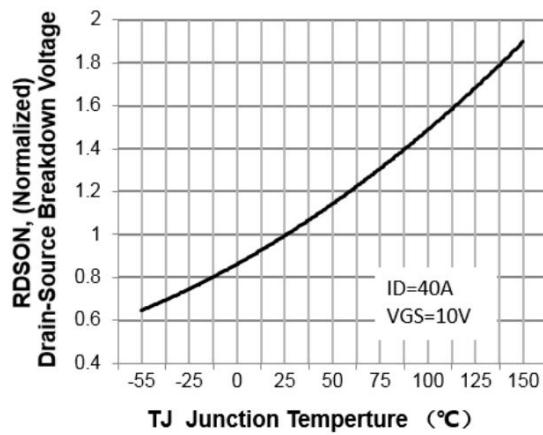


Figure 8. On-Resistance Variation
vs Temperature

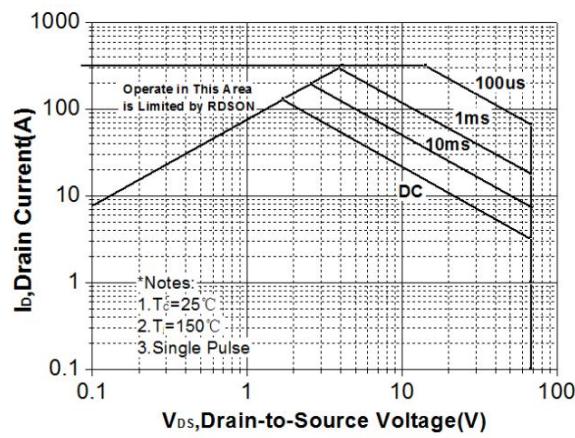


Figure 9. Maximum Safe Operating Area

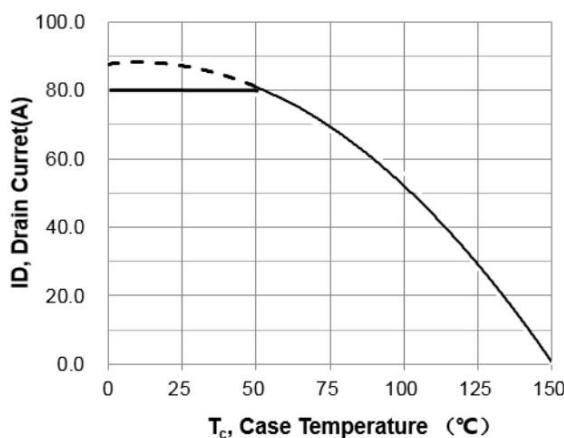


Figure 10. Maximum Drain Current
vs Case Temperature

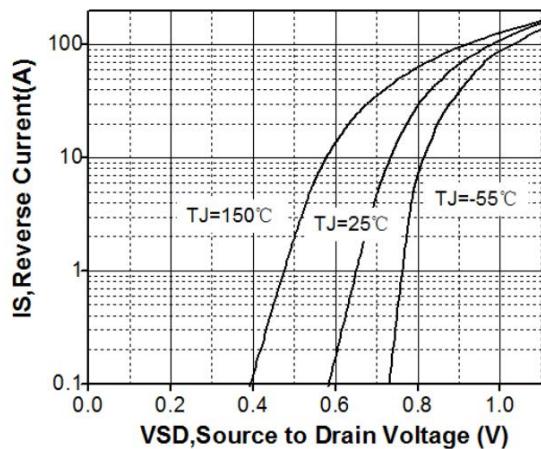


Figure 11. Body Diode Forward Voltage
Vs Reverse Drain Current

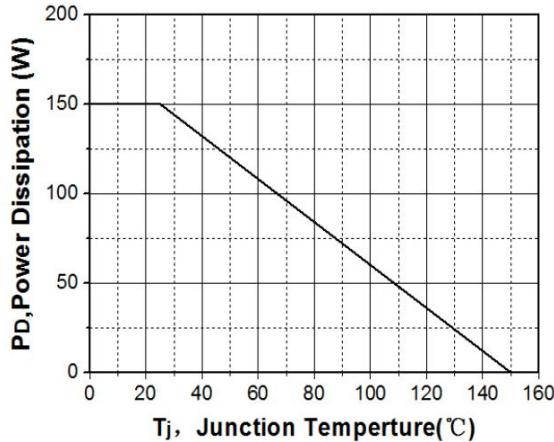


Figure 12 . Power Dissipation vs Junction
Temperature

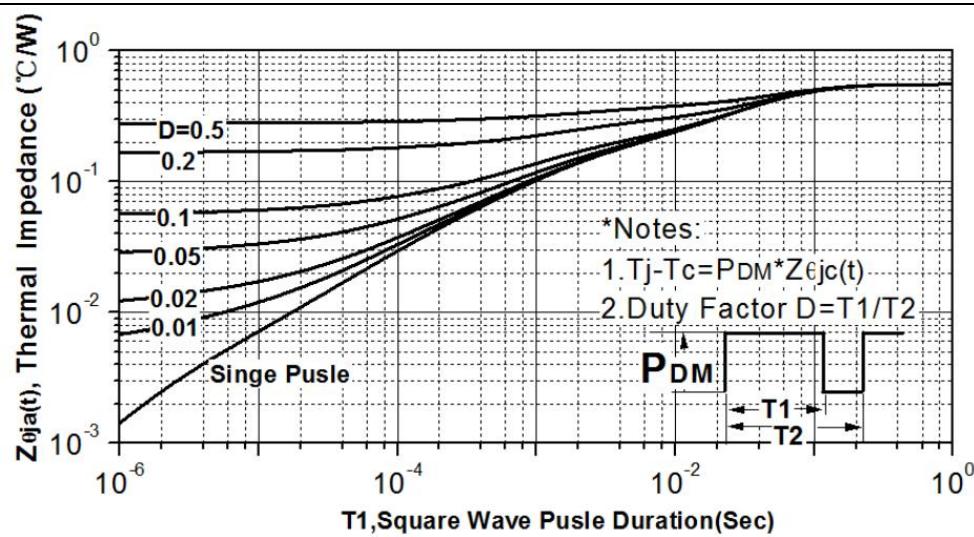


Figure 13. Transient Thermal Response Curve

Test Circuit

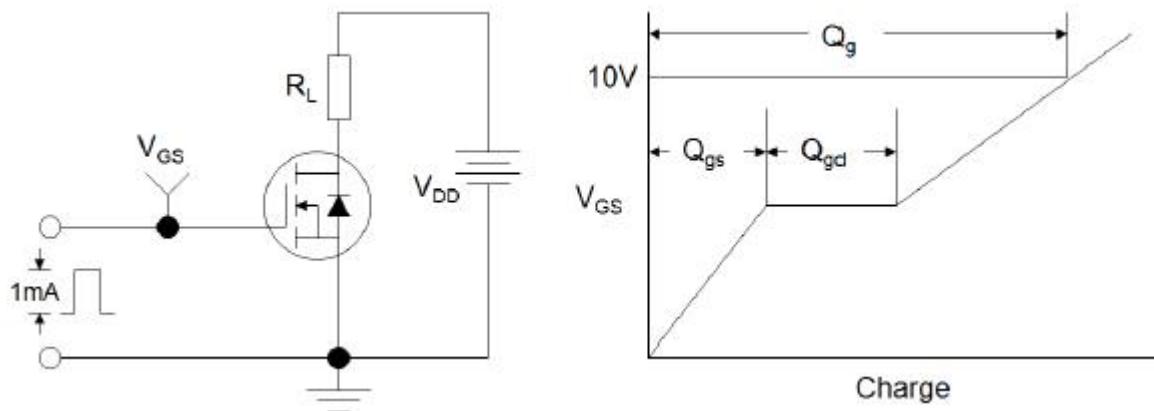


Figure 14. Gate Charge Test Circuit & Waveform

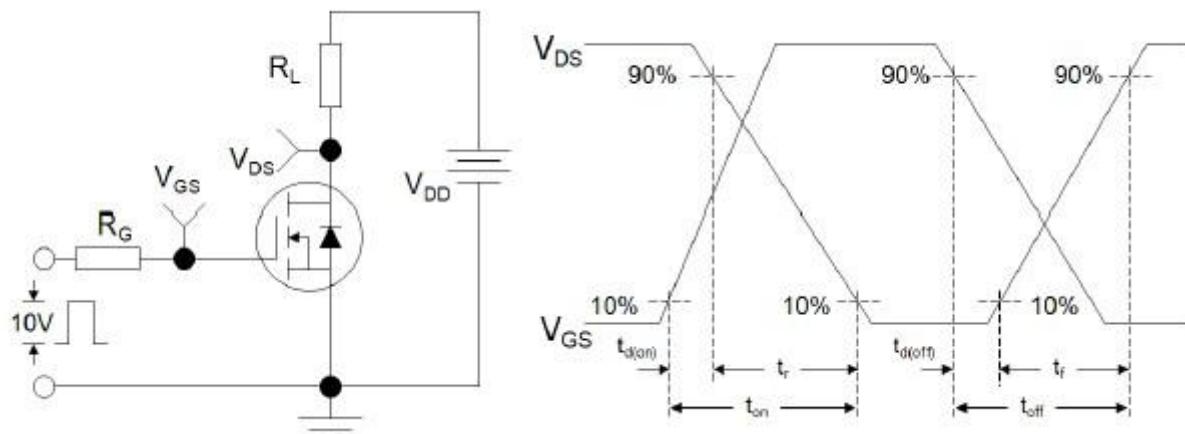


Figure 15. Switching time test circuit & waveform

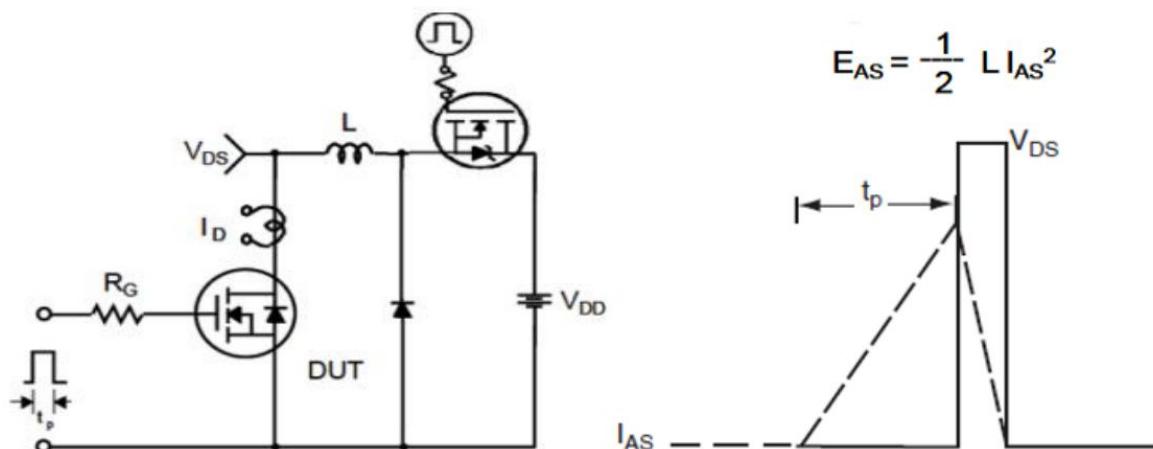


Figure 16. Unclamped Inductive switching test circuit & waveform

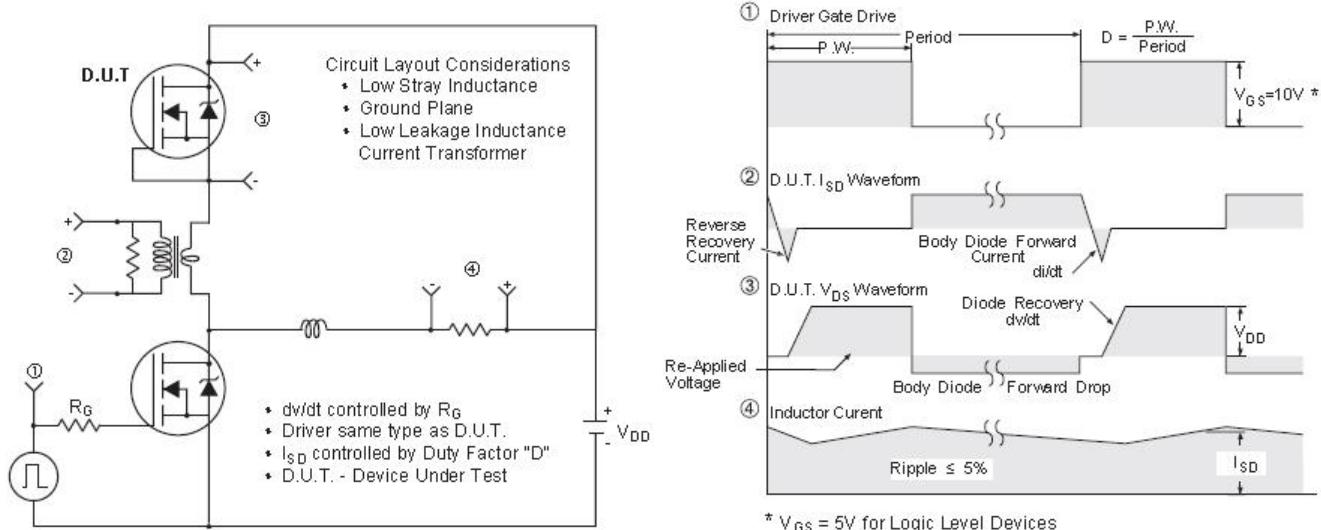
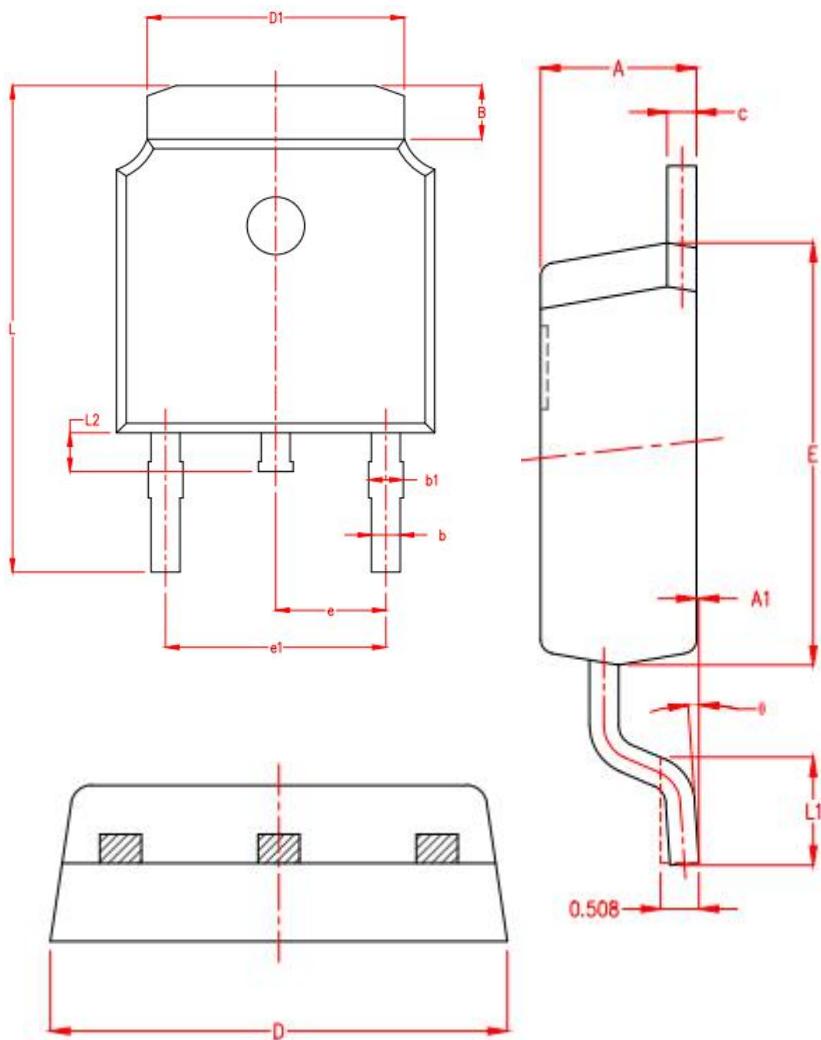


Figure 17. Peak diode recovery dv/dt test circuit & waveform

TO-252 Package Information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	2.15	2.25	2.35
A1	0.00	0.06	0.12
B	0.96	1.11	1.26
b	0.59	0.69	0.79
b1	0.69	0.81	0.93
c	0.34	0.42	0.50
D	6.45	6.60	6.75
D1	5.23	5.33	5.43
E	5.95	6.10	6.25
e	2.286TYP.		
e1	4.47	4.57	4.67
L	9.90	10.10	10.30
L1	1.40	1.55	1.70
L2	0.60	0.80	1.00
θ	0°	4°	8°